(intel) PENTIUM' inside

Intel® Pentium® Processor D1517 (6M Cache, 1.60 GHz)

| Specifications | | | |
|--|------|----------------|--|
| - Essentials | | | |
| Status | | Launched | |
| Launch Date | | Q4'15 | |
| Processor Number | | D1517 | |
| Cache | | 6 MB | |
| Instruction Set | | 64-bit | |
| Instruction Set Extensions | | AVX 2.0 | |
| Embedded Options Available | Q | Yes | |
| Lithography | | 14 nm | |
| Recommended Customer Price | | TRAY: \$194.00 | |
| Datasheet | | Link | |
| Conflict Free | | Yes | |
| Scalability | | 1S Only | |
| Product Brief | | Link | |
| - Performance | | | |
| # of Cores | | 4 | |
| # of Threads | | 8 | |
| Processor Base Frequency | | 1.6 GHz | |
| Max Turbo Frequency | | 2.2 GHz | |
| TDP | 25 W | | |
| - Memory Specifications | | | |
| Max Memory Size (dependent on memory type) | | 128 GB | |
| Memory Types | | DDR4, DDR3 | |
| Max # of Memory Channels | | 2 | |
| ECC Memory Supported [‡] | Q | Yes | |
| - Graphics Specifications | | | |
| Processor Graphics [‡] | | None | |
| - Expansion Options | | | |
| PCI Express Revision | | 2.0/3.0 | |
| PCI Express Configurations [‡] | | x4 x8 x16 | |
| Max # of PCI Express Lanes | | 32 | |

| - I/O Specifications | | | |
|--|-------------------|-----------------|--|
| USB Revision | | 2.0/3.0 | |
| # of USB Ports | | 8 | |
| Total # of SATA Ports | | 6 | |
| Integrated LAN | | Yes | |
| General Purpose IO | | Yes | |
| UART | | Yes | |
| | | 1 | |
| - Package Specifications | | | |
| Max CPU Configuration | | 1 | |
| Package Size | | 37.5mm x 37.5mm | |
| Sockets Supported | Sockets Supported | | |
| Low Halogen Options Available | | See MDDS | |
| - Advanced Technologies | | | |
| Intel® Turbo Boost Technology [‡] | | 2.0 | |
| Intel® Hyper-Threading Technology ‡ | Q | Yes | |
| Intel® Virtualization Technology (VT-x) ‡ | | Yes | |
| Intel® Virtualization Technology for Directed I/O (VT-d) ‡ | Q | Yes | |
| Intel® VT-x with Extended Page Tables (EPT) ‡ | Q | Yes | |
| Intel® TSX-NI | | Yes | |
| Intel® 64 ‡ | Q | Yes | |
| Idle States | | Yes | |
| Enhanced Intel SpeedStep® Technology | Q | Yes | |
| Thermal Monitoring Technologies | | Yes | |
| Intel® Identity Protection Technology ‡ | | Yes | |
| | | | |
| - Intel® Data Protection Technology | | v | |
| Intel® AES New Instructions | Q | Yes | |
| Secure Key | | Yes | |
| - Intel® Platform Protection Technology | | | |
| Trusted Execution Technology ‡ | Q | Yes | |
| Execute Disable Bit ‡ | | Yes | |
| OS Guard | | Yes | |
| - Networking Specifications | | | |
| SFI Interface | | Yes | |
| KR Interface | | Yes | |
| KR4 Interface | | No | |

| KX Interface | Yes |
|---------------|-----|
| KX4 Interface | Yes |
| 100Base-T | No |
| 1000Base-T | Yes |
| 10GBase-T | Yes |
| | |

Ordering and Spec Information

Trade Compliance Information

| ECCN | CCATS | US HTS |
|----------|-----------|------------|
| 5A992CN3 | G071701++ | 8542310000 |

Ordering and Spec Information

| Spec Code | Ordering Code | Step | RCP |
|-----------------------------|--|------|----------|
| Intel® Pentium® Processor D | 11517 (6M Cache, 1.60 GHz) FC-BGA14C, Tray | | |
| SR2GG | GG8067402612800 | V2 | \$194.00 |

Download Drivers



Intel® Processor Frequency ID Utility Windows* version [FIDXX32.MSI]

The Intel® Processor Frequency ID Utility can be used to identify Intel® processors.

Version: 7.2 (Latest) **Date:** 11/16/2004

Operating Systems: Windows XP Home Edition*, Windows XP Professional*, Windows 98 SE*, 2 more



Intel® Processor Frequency ID Utility Bootable version [BFID X25.EXE]

The bootable version of Intel® Processor Frequency ID Utility can be used to identify Intel® processors for non-OS dependant systems.

Version: 7.2 (Latest) **Date:** 11/15/2004

Operating Systems: OS Independent



CPUID for DOS* [CPUID.EXE]

This file contains the processor identification utility.

Version: 0.0 (Previously Date: 8/17/2000

Released)
Operating Systems: DOS



CPUInfo Package [cpuinfo.zip]

This file contains the processor identification utility.

Version: 0.0 (Previously Date: 8/17/2000

Released)

Operating Systems: OS Independent

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

 $Some\ products\ can \ support\ AES\ New\ Instructions\ with\ a\ Processor\ Configuration\ update,\ in\ particular,\ i7-2630QM/i7-2635QM,\ i5-2430M/i5-2435M,\ i5-2410M/i5-2415M.$

Please contact OEM for the BIOS that includes the latest Processor configuration update.

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading for more information including details on which processors support Intel® HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

The Recommended Customer Price ("RCP") is pricing guidance for Intel products. Prices are for direct Intel customers, typically represent 1,000-unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see http://www.intel.com/performance.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See http://www.intel.com/content/www/us/en/processors/processor-numbers.html for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

Send us your feedback!